

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2687313

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>HIROAKI IGARASHI</td> <td>04/12/2013</td> </tr> <tr> <td>SATORU SHIGETA</td> <td>04/12/2013</td> </tr> <tr> <td>TAKASHI OGURA</td> <td>04/12/2013</td> </tr> </tbody> </table>		Name	Execution Date	HIROAKI IGARASHI	04/12/2013	SATORU SHIGETA	04/12/2013	TAKASHI OGURA	04/12/2013
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RECEIVING PARTY DATA									
<table border="1"> <tr> <td>Name:</td> <td>HITACHI AUTOMOTIVE SYSTEMS, LTD.</td> </tr> <tr> <td>Street Address:</td> <td>2520, TAKABA</td> </tr> <tr> <td>City:</td> <td>HITACHINAKA-SHI, IBARAKI</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> </table>		Name:	HITACHI AUTOMOTIVE SYSTEMS, LTD.	Street Address:	2520, TAKABA	City:	HITACHINAKA-SHI, IBARAKI	State/Country:	JAPAN
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PROPERTY NUMBERS Total: 1									
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CORRESPONDENCE DATA									
<p>Fax Number: (202)628-8844 Phone: 2026242500 Email: kdavis@crowell.com <i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i> Correspondent Name: CROWELL & MORING LLP Address Line 1: P.O. BOX 14300 Address Line 2: INTELLECTUAL PROPERTY DEPARTMENT Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 200444300</p>									
ATTORNEY DOCKET NUMBER:	106734.65546US								
NAME OF SUBMITTER:	MICHAEL H. JACOBS								
Signature:	/Michael H. Jacobs/								
Date:	01/17/2014								
Total Attachments: 1 source=65546usassign#page1.tif									

ASSIGNMENT

(讓 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me by Hitachi Automotive Systems, Ltd., a corporation organized under the laws of Japan, located at 2520, Takaba, Hitachinaka-shi, Ibaraki Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi Automotive Systems, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi Automotive Systems, Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi Automotive Systems, Ltd.,

Signed on the date(s) indicated aside our signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	<u>Hiroaki IGARASHI</u> Hiroaki IGARASHI	<u>4/12/2013</u>
2)	<u>Satoru SHIGETA</u> Satoru SHIGETA	<u>4/12/2013</u>
3)	<u>Takashi OGURA</u> Takashi OGURA	<u>4/12/2013</u>
4)	_____	_____
5)	_____	_____
6)	_____	_____
7)	_____	_____
8)	_____	_____
9)	_____	_____
10)	_____	_____

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